10-µm InGaAsP/InP SPADs for 1064 nm detection with 36% PDP and 118 ps timing jitter

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Abstract-In this work, we present a family of planar In-GaAsP/InP SPADs with a diameter of 10 µm targeting 1064 nm wavelength detection. TCAD simulations enabled the determination of Zn diffusion depths, thereby achieving low noise and uniform photoresponse. Devices with 1.5-um. 1.3-µm, and 0.75-µm multiplication region thicknesses were fabricated. The device with a 1.5-µm multiplication region demonstrated 53 kcps DCR, 118 ps timing jitter at 5 Vex, and 36% PDP at 9 V_{ex} . The measurements were done from the backside without a metal reflector, all at 300K. The DCR was reduced to 14.1 kcps at 273K, 5.5 kcps at 253K, and 2.75 kcps at 225K at 5 V_{ex} . The operating frequency can be increased up to 500 kHz with only 11.8% and to 200 kHz with 5.8% afterpulsing at 300K. The active area scanning results indicated that the photoresponse is almost flat at and above 5 Vex. Thinner multiplication regions showed higher PDPs and lower jitter, at a cost of higher noise.

I. INTRODUCTION

Single-photon detection at 1064 nm wavelength is useful in long-haul light detection and ranging (LiDAR) and in free-space communications [1]. Medical applications, such as time-gated diffuse correlation spectroscopy for blood flow measurements can also make use of such a detector [2]. Highpower 1064 nm Nd:YAG lasers enable a variety of similar experiments and are appealing to diversify the applications. Since the photon detection probability (PDP) of CMOSbased SPADs reduces towards near-infrared (NIR) due to the low silicon absorption coefficient, superconducting nanowire single-photon detectors (SNSPDs) and InGaAsP/InP singlephoton avalanche diodes (SPADs) have emerged as the best alternatives to develop single-photon cameras operating at 1064 nm. However, InGaAsP/InP SPADs perform well at much higher temperatures than SNSPDs, and even at room temperature, enabling scalable and compact solutions that are cost-effective as well.

II. RESULTS

SPADs utilize a separate absorption-charge-multiplication (SACM) structure and the double zinc (Zn) diffusion technique to form the multiplication and guard ring (GR) regions (Fig. 1). The n-contact was carried to the top surface, allowing to illuminate SPADs from the backside. The absorber thickness is 1 μ m, and the charge layer doping is larger than 2×10^{17} cm⁻³ to keep the electric field sufficient to deplete the absorber before breakdown is reached (Fig. 2). We designed, fabricated, and fully characterized 10- μ m diameter SPADs with 1.5- μ m, 1.3- μ m, and 0.75- μ m multiplication region thickness.

According to avalanche breakdown probability simulations in TCAD, a 0.5-µm depth difference between shallow and deep Zn diffusions was the preferred solution. This could potentially provide lower noise at the cost of a less uniform photoresponse over the active area (Fig. 3). The SEM image of the fabricated device with a 1.3-µm multiplication region prove that the Zn diffusion depths are close to the planned values (Fig. 4). The measured I-V curves at 300K indicate the avalanche breakdown and punch-through voltages for each device (Fig. 5). In the remaining measurements, the SPADs were operated in time-gating mode with 50 k Ω ballast resistor and a 100 ns gate-on time. The gating frequency sweep of each device showed that devices can be operated up to 500 kHz with low afterpulsing probability (APP) at 300K (Fig. 6). With 10 kHz gating, a median DCR of 53 kcps was obtained with a multiplication region thickness of 1.5-µm, 302 kcps with 1.3 µm, and 2130 kcps with 0.75 µm, where the DCR was normalized with gate-on time. The median DCR was reduced to 14.1 kcps at 273K, 5.5 kcps at 253K, and 2.75 kcps at 225K, for a 1.5-µm multiplication region at 5 Vex (Fig. 7). Active area scanning was performed with a 1060 nm pulsed laser, demonstrating that the response difference between the edge and center of the active region becomes smaller when increasing V_{ex} , and that a uniform response can be achieved at and above 5 V_{ex} (Fig. 8). The PDP obtained with a monochromator and wide-spectrum lamp at 1060 nm and 5 Vex was 19.5% for 1.5-µm multiplication region thickness, 20.4% for 1.3 µm, and 21.5% for 0.75 µm (Fig. 9). A high PDP of 36% at 9 Vex was achieved with a 1.5um multiplication. Inter-arrival avalanche histograms indicated that APPs of only 11.1% and 5.8% can be achieved at 500 kHz and 200 kHz gating and 300K, respectively (Fig. 10). The timing jitter was acquired via time-correlated single-photon counting (TCSPC), yielding as 118.4 ps, 110 ps, and 84 ps (FWHM) after deconvolution (Fig. 11). The comparison with state-of-the-art InGaAsP SPADs shows that fabricated devices achieved the smallest sizes, with high PDP, and low timing jitter (Fig. 12), while further optimization is to be expected.

REFERENCES

- L. Xue, Z. Li, L. Zhang, D. Zhai, Y. Li, S. Zhang, M. Li, L. Kang, J. Chen, P. Wu *et al.*, "Satellite laser ranging using superconducting nanowire single-photon detectors at 1064 nm wavelength," *Optics letters*, vol. 41, no. 16, pp. 3848–3851, 2016.
- [2] C.-S. Poon, D. S. Langri, B. Rinehart, T. M. Rambo, A. J. Miller, B. Foreman, and U. Sunar, "First-in-clinical application of a time-gated diffuse correlation spectroscopy system at 1064 nm using superconducting nanowire single photon detectors in a neuro intensive care unit," *Biomedical Optics Express*, vol. 13, no. 3, pp. 1344–1356, 2022.



Fig. 1: The cross-section and an optical image of fabricated SPADs.



Fig. 4: SEM image belonging to a device with a 1.3- μ m multiplication region.



Fig. 2: Electric field simulations in TCAD at 300K.



Fig. 3: Avalanche breakdown probability simulations for devices with a 0.5-µm Zn diffusion depth difference at 300K.



Fig. 5: I-V characteristics of the devices with (a) $1.5-\mu m$, (b) $1.3-\mu m$, and (c) $0.75-\mu m$ multiplication regions at 300K.



Fig. 6: Gating frequency sweep of the devices with (a) 1.5-µm, (b) 1.3-µm, and (c) 0.75-µm multiplication regions.



Fig. 7: DCR measurements of the devices with (a) 1.5-µm, (b) 1.3-µm, and (c) 0.75-µm multiplication regions with 10 kHz gating and 100 ns gate-on time. Note: Three devices (S1, S2, and S3) were characterized with a 10-µm diameter. S2 corresponds to the median device.



Fig. 8: Active area scanning of the SPAD with a $1.3-\mu m$ multiplication region from the (a) side and (b) top view by utilizing a 1060 nm pulsed laser at 300K.



Fig. 9: PDP measurements of the devices with (a) 1.5-µm, (b) 1.3-µm, and (c) 0.75-µm multiplication regions at 300K and with 10 kHz gating and 100 ns gate-on time.



Fig. 10: Inter-arrival avalanche pulse histograms of the devices at various temperatures and gating frequencies with 100 ns gate-on time.



Fig. 11: Timing jitter measurements of the devices with (a) 1.5-µm, (b) 1.3-µm, and (c) 0.75-µm multiplication regions at 300K.



(with active-quenching technique, Journal of Applied Philpsics, vol. 122, no. 1, 2017.
(6) Y. May, Y. Gu, X. Li, B. Yang, X. Shao, T. Li, Y. Zhang, H. Gong, and J. Fang, "InSGAP/InP geiger-mode avalanche photodiode towards sub-khz dark count rate at 20% photon detection efficiency". Journal of J (phytove Technology, vol. 40, no. 22, pp. 7364–7374, 2022.
(7) M. Zhou, W. Wang, H. Qu, H. Han, Y. Zhu, Z. Guo, L. Gui, X. Wang, and W. Lu, "InGaAsP/InP single photon avalanche diodes with ultra-high photon detection efficiency". *Optical and Quantum Electronics*, vol. 52, pp. 1–9, 2020.

Fig. 12: Comparison of the developed SPADs with the stateof-the-art InGaAsP SPADs targeting 1064 nm detection.